HM514260 Series — Preliminary

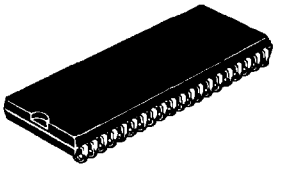
262,144-Word x 16-Bit Dynamic Random Access Memory

■ DESCRIPTION

The Hitachi HM514260 are CMOS dynamic RAM organized as 262,144-word x 16-bit. HM514260 have realized higher density, higher performance and various functions by employing 0.8 μm CMOS process technology and some new CMOS circuit design technologies. The HM514260 offer Fast Page Mode as a high speed access mode.

Multiplexed address input permits the HM514260 to be packaged in standard 400 mil 40-pin plastic SOJ, standard 475 mil 40-pin plastic ZIP.

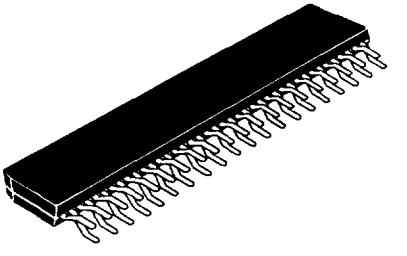
HM514260JP Series



3DCP40D

(CP-40D)

HM514260ZP Series



3DZP40

(ZP-40)

■ FEATURES

- Single 5V (±10%)
- High Speed
  - Access Time .....70 ns/80 ns/100 ns (max)
- Low Power Dissipation
  - Active Mode .....935 mW/825 mW/715 mW (max)
  - Standby Mode.....11 mW (max)
- Fast Page Mode Capability
- 512 Refresh Cycles .....(8 ms)
- 2$\overline{CAS}$ Byte Control
- 3 Variations of Refresh
  - $\overline{RAS}$ Only Refresh
  - $\overline{CAS}$ Before $\overline{RAS}$ Refresh
  - Hidden Refresh

■ ORDERING INFORMATION

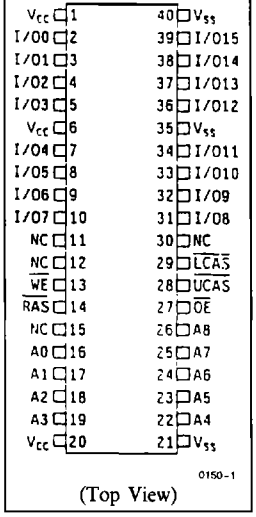
Part No.	Access Time	Package
HM514260JP-7	70 ns	400 mil 40-pin
HM514260JP-8	80 ns	Plastic SOJ
HM514260JP-10	100 ns	(CP-40D)
HM514260ZP-7	70 ns	475 mil 40-pin
HM514260ZP-8	80 ns	Plastic ZIP
HM514260ZP-10	100 ns	(ZP-40)

■ PIN DESCRIPTION

Pin Name	Function
A_0–A_8	Address Input —Row Address A_0–A_8 —Column Address A_0–A_8 —Refresh Address A_0–A_8
I/O_0–I/O_{15}	Data-in/Data-out
$\overline{RAS}$	Row Address Strobe
$\overline{UCAS}$, $\overline{LCAS}$	Column Address Strobe
$\overline{WE}$	Read/Write Enable
$\overline{OE}$	Output Enable
V_{CC}	Power (+5V)
V_{SS}	Ground

■ PIN OUT

HM514260JP Series



0150-1

(Top View)

HM514260ZP Series

I/O_9	2		1	I/O_8
I/O_{11}	4		3	I/O_{10}
I/O_{12}	6		5	V_{SS}
I/O_{14}	8		7	I/O_{13}
V_{SS}	10		9	I/O_{15}
I/O_0	12		11	V_{CC}
I/O_2	14		13	I/O_1
V_{CC}	16		15	I/O_3
I/O_5	18		17	I/O_4
I/O_7	20		19	I/O_6
NC	22		21	NC
$\overline{RAS}$	24		23	$\overline{WE}$
A_0	26		25	NC
A_2	28		27	A_1
V_{CC}	30		29	A_3
A_4	32		31	V_{SS}
A_6	34		33	A_5
A_8	36		35	A_7
$\overline{UCAS}$	38		37	$\overline{OE}$
NC	40		39	$\overline{LCAS}$

(Bottom View)

■ TRUTH TABLE

Inputs					I/O		Operation
$\overline{RAS}$	$\overline{LCAS}$	$\overline{UCAS}$	$\overline{WE}$	$\overline{OE}$	I/O_0–I/O_7	I/O_8–I/O_{15}	
H	H	H	H	H	High-Z	High-Z	Standby
L	H	H	H	H	High-Z	High-Z	Refresh
L	L	H	H	L	D_{out}	High-Z	Lower Byte Read
L	H	L	H	L	High-Z	D_{out}	Upper Byte Read
L	L	L	H	L	D_{out}	D_{out}	Word Read
L	L	H	L	H	D_{in}	Don't Care	Lower Byte Write
L	H	L	L	H	Don't Care	D_{in}	Upper Byte Write
L	L	L	L	H	D_{in}	D_{in}	Word Write
L	L	L	H	H	High-Z	High-Z	

■ ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Voltage on Any Pin Relative to V_{SS}	V_T	−1.0 to +7.0	V
Supply Voltage Relative to V_{SS}	V_{CC}	−1.0 to +7.0	V
Short Circuit Output Current	I_{out}	50	mA
Power Dissipation	P_T	1.0	W
Operating Temperature	T_{opr}	0 to +70	°C
Storage Temperature	T_{stg}	−55 to +125	°C

■ ELECTRICAL CHARACTERISTICS

• Recommended DC Operating Conditions (T_A = 0 to +70°C)

Parameter		Symbol	Min	Typ	Max	Unit	Note
Supply Voltage		V_{SS}	0	0	0	V	
		V_{CC}	4.5	5.0	5.5	V	1
Input High Voltage		V_{IH}	2.4	—	6.5	V	1
Input Low Voltage	(I/O Pin)	V_{IL}	−1.0	—	0.8	V	1
	(Others)	V_{IL}	−2.0	—	0.8	V	1

Note: 1. All voltage referenced to V_{SS}.

• DC Electrical Characteristics (T_A = 0 to +70°C, V_{CC} = 5V ±10%, V_{SS} = 0V)

Parameter	Symbol	HM514260-7		HM514260-8		HM514260-10		Unit	Test Conditions	Note
		Min	Max	Min	Max	Min	Max			
Operating Current	I_{CC1}	—	170	—	150	—	130	mA	$\overline{RAS}$ Cycling $\overline{LCAS}$ or $\overline{UCAS}$ Cycling t_{RC} = Min	1, 2
Standby Current	I_{CC2}	—	2	—	2	—	2	mA	TTL Interface $\overline{RAS}$, $\overline{LCAS}$, $\overline{UCAS}$ = V_{IH} D_{out} = High-Z	
		—	1	—	1	—	1	mA	CMOS Interface, $\overline{RAS}$, $\overline{LCAS}$, $\overline{UCAS}$ ≥ V_{CC} − 0.2V, D_{out} = High-Z	
$\overline{RAS}$ Only Refresh Current	I_{CC3}	—	150	—	130	—	110	mA	t_{RC} = Min	2
Standby Current	I_{CC5}	—	5	—	5	—	5	mA	$\overline{RAS}$ = V_{IH}, $\overline{LCAS}$ or $\overline{UCAS}$ = V_{IL}, D_{out} = Enable	1
$\overline{CAS}$ Before $\overline{RAS}$ Refresh Current	I_{CC6}	—	150	—	130	—	110	mA	t_{RC} = Min	
Fast Page Mode Current	I_{CC7}	—	130	—	120	—	110	mA	t_{PC} = Min	1, 3
Input Leakage Current	I_{LI}	−10	10	−10	10	−10	10	μA	0V ≤ V_{in} ≤ 7V	

• **DC Electrical Characteristics** (T_A = 0 to +70°C, V_{CC} = 5V ±10%, V_{SS} = 0V) (continued)

Parameter	Symbol	HM514260-7		HM514260-8		HM514260-10		Unit	Test Conditions	Note
		Min	Max	Min	Max	Min	Max			
Output Leakage Current	I_{LO}	−10	10	−10	10	−10	10	μA	0V ≤ V_{out} ≤ 7V, D_{out} = Disable	
Output High Voltage	V_{OH}	2.4	V_{CC}	2.4	V_{CC}	2.4	V_{CC}	V	High I_{out} = −5 mA	
Output Low Voltage	V_{OL}	0	0.4	0	0.4	0	0.4	V	Low I_{out} = 4.2 mA	

Notes: 1. I_{CC} depends on output load condition when the device is selected, I_{CC} max is specified at the output open condition.
2. Address can be changed once or less while $\overline{RAS}$ = V_{IL}.
3. Address can be changed once or less while $\overline{LCAS}$ and $\overline{UCAS}$ = V_{IH}.

• **Capacitance** (T_A = 25°C, V_{CC} = 5V ±10%)

Parameter	Symbol	Typ	Max	Unit	Note
Input Capacitance (Address)	C_{I1}	—	5	pF	1
Input Capacitance (Clocks)	C_{I2}	—	7	pF	1
Output Capacitance (Data-in, Data-out)	$C_{I/O}$	—	10	pF	1, 2

Notes: 1. Capacitance measured with Boonton Meter or effective capacitance measuring method.
2. $\overline{LCAS}$ and $\overline{UCAS}$ = V_{IH} to disable D_{out}.

• **AC Characteristics** (T_A = 0 to +70°C, V_{CC} = 5V ±10%, V_{SS} = 0V)[1, 14, 15]

Read, Write, Read-Modify-Write and Refresh Cycles (Common Parameters)

Parameter	Symbol	HM514260-7		HM514260-8		HM514260-10		Unit	Note
		Min	Max	Min	Max	Min	Max		
Random Read or Write Cycle Time	t_{RC}	130	—	150	—	180	—	ns	
$\overline{RAS}$ Precharge Time	t_{RP}	50	—	60	—	70	—	ns	
$\overline{RAS}$ Pulse Width	t_{RAS}	70	10000	80	10000	100	10000	ns	
$\overline{CAS}$ Pulse Width	t_{CAS}	20	10000	20	10000	25	10000	ns	
Row Address Setup Time	t_{ASR}	0	—	0	—	0	—	ns	
Row Address Hold Time	t_{RAH}	10	—	10	—	15	—	ns	
Column Address Setup Time	t_{ASC}	0	—	0	—	0	—	ns	
Column Address Hold Time	t_{CAH}	15	—	15	—	20	—	ns	
$\overline{RAS}$ to $\overline{CAS}$ Delay Time	t_{RCD}	20	50	20	60	25	75	ns	8
$\overline{RAS}$ to Column Address Delay Time	t_{RAD}	15	35	15	40	20	55	ns	9
$\overline{RAS}$ Hold Time	t_{RSH}	20	—	20	—	25	—	ns	
$\overline{CAS}$ Hold Time	t_{CSH}	70	—	80	—	100	—	ns	
$\overline{CAS}$ to $\overline{RAS}$ Precharge Time	t_{CRP}	10	—	10	—	10	—	ns	
$\overline{OE}$ to D_{in} Delay Time	t_{ODD}	20	—	20	—	25	—	ns	
$\overline{OE}$ Delay Time from D_{in}	t_{DZO}	0	—	0	—	0	—	ns	
$\overline{CAS}$ Setup Time from D_{in}	t_{DZC}	0	—	0	—	0	—	ns	
Transition Time (Rise and Fall)	t_T	3	50	3	50	3	50	ns	7
Refresh Period	t_{REF}	—	8	—	8	—	8	ms	

Read Cycle

Parameter	Symbol	HM514260-7		HM514260-8		HM514260-10		Unit	Note
		Min	Max	Min	Max	Min	Max		
Access Time from $\overline{RAS}$	t_{RAC}	—	70	—	80	—	100	ns	2, 3
Access Time from $\overline{CAS}$	t_{CAC}	—	20	—	20	—	25	ns	3, 4, 13
Access Time from Address	t_{AA}	—	35	—	40	—	45	ns	3, 5, 13
Access Time from $\overline{OE}$	t_{OAC}	—	20	—	20	—	25	ns	
Read Command Setup Time	t_{RCS}	0	—	0	—	0	—	ns	
Read Command Hold Time to $\overline{CAS}$	t_{RCH}	0	—	0	—	0	—	ns	
Read Command Hold Time to $\overline{RAS}$	t_{RRH}	0	—	0	—	0	—	ns	
Column Address to $\overline{RAS}$ Lead Time	t_{RAL}	35	—	40	—	55	—	ns	
Output Buffer Turn-off Time	t_{OFF1}	0	15	0	15	0	20	ns	6
Output Buffer Turn-off to $\overline{OE}$	t_{OFF2}	0	15	0	15	0	20	ns	6
$\overline{CAS}$ to D_{in} Delay Time	t_{CDD}	15	—	15	—	20	—	ns	

Write Cycle

Parameter	Symbol	HM514260-7		HM514260-8		HM514260-10		Unit	Note
		Min	Max	Min	Max	Min	Max		
Write Command Setup Time	t_{WCS}	0	—	0	—	0	—	ns	10
Write Command Hold Time	t_{WCH}	15	—	15	—	20	—	ns	
Write Command Pulse Width	t_{WP}	10	—	10	—	20	—	ns	
Write Command to $\overline{RAS}$ Lead Time	t_{RWL}	20	—	20	—	25	—	ns	
Write Command to $\overline{CAS}$ Lead Time	t_{CWL}	20	—	20	—	25	—	ns	
Data-in Setup Time	t_{DS}	0	—	0	—	0	—	ns	11
Data-in Hold Time	t_{DH}	15	—	15	—	20	—	ns	11

Read-Modify-Write Cycle

Parameter	Symbol	HM514260-7		HM514260-8		HM514260-10		Unit	Note
		Min	Max	Min	Max	Min	Max		
Read-Modify-Write Cycle Time	t_{RWC}	180	—	200	—	245	—	ns	
$\overline{RAS}$ to $\overline{WE}$ Delay Time	t_{RWD}	95	—	105	—	135	—	ns	10
$\overline{CAS}$ to $\overline{WE}$ Delay Time	t_{CWD}	45	—	45	—	60	—	ns	10
Column Address to $\overline{WE}$ Delay Time	t_{AWD}	60	—	65	—	80	—	ns	10, 13
$\overline{OE}$ to Hold Time from $\overline{WE}$	t_{OEH}	20	—	20	—	25	—	ns	

Refresh Cycle

Parameter	Symbol	HM514260-7		HM514260-8		HM514260-10		Unit	Note
		Min	Max	Min	Max	Min	Max		
$\overline{CAS}$ Setup Time ($\overline{CAS}$ Before $\overline{RAS}$ Refresh Cycle)	t_{CSR}	10	—	10	—	10	—	ns	
$\overline{CAS}$ Hold Time ($\overline{CAS}$ Before $\overline{RAS}$ Refresh Cycle)	t_{CHR}	10	—	10	—	10	—	ns	
$\overline{RAS}$ Precharge to $\overline{CAS}$ Hold Time	t_{RPC}	10	—	10	—	10	—	ns	
$\overline{CAS}$ Precharge Time in Normal Mode	t_{CPN}	10	—	10	—	10	—	ns	

Fast Page Mode Cycle

Parameter	Symbol	HM514260-7		HM514260-8		HM514260-10		Unit	Note
		Min	Max	Min	Max	Min	Max		
Fast Page Mode Cycle Time	t_{PC}	45	—	50	—	55	—	ns	
Fast Page Mode $\overline{CAS}$ Precharge Time	t_{CP}	10	—	10	—	10	—	ns	
Fast Page Mode $\overline{RAS}$ Pulse Width	t_{RASC}	—	100000	—	100000	—	100000	ns	12
Access Time from $\overline{CAS}$ Precharge	t_{ACP}	—	40	—	45	—	50	ns	3, 13
$\overline{RAS}$ Hold Time from $\overline{CAS}$ Precharge	t_{RHCP}	40	—	45	—	50	—	ns	
Fast Page Mode Read-Modify-Write Cycle $\overline{CAS}$ Precharge to $\overline{WE}$ Delay Time	t_{CPW}	65	—	70	—	85	—	ns	
Fast Page Mode Read-Modify-Write Cycle Time	t_{PCM}	95	—	100	—	110	—	ns	

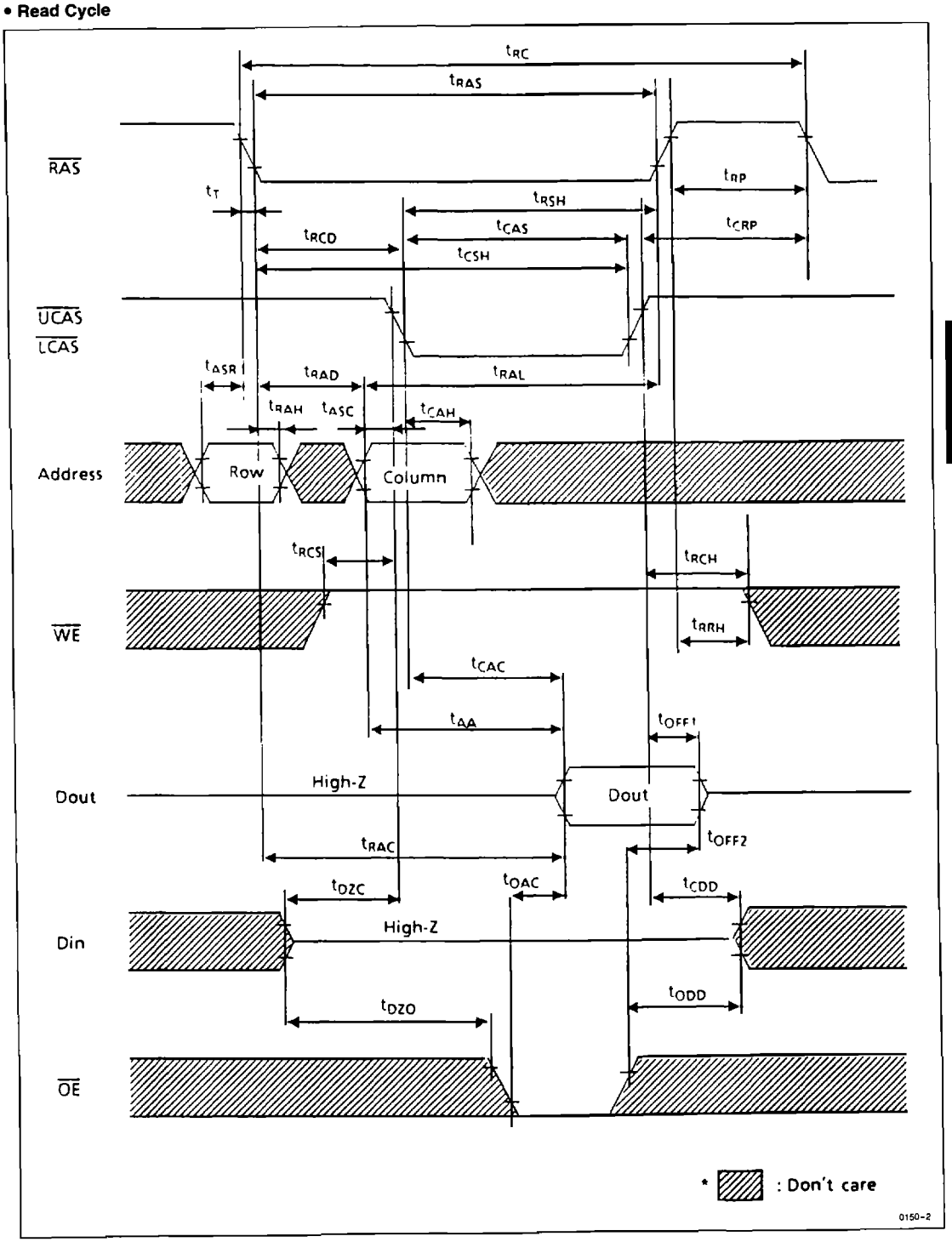
Counter Test Cycle

Parameter	Symbol	HM514260-7		HM514260-8		HM514260-10		Unit	Note
		Min	Max	Min	Max	Min	Max		
$\overline{CAS}$ Precharge Time in Counter Test Cycle	t_{CPT}	50	—	50	—	50	—	ns	

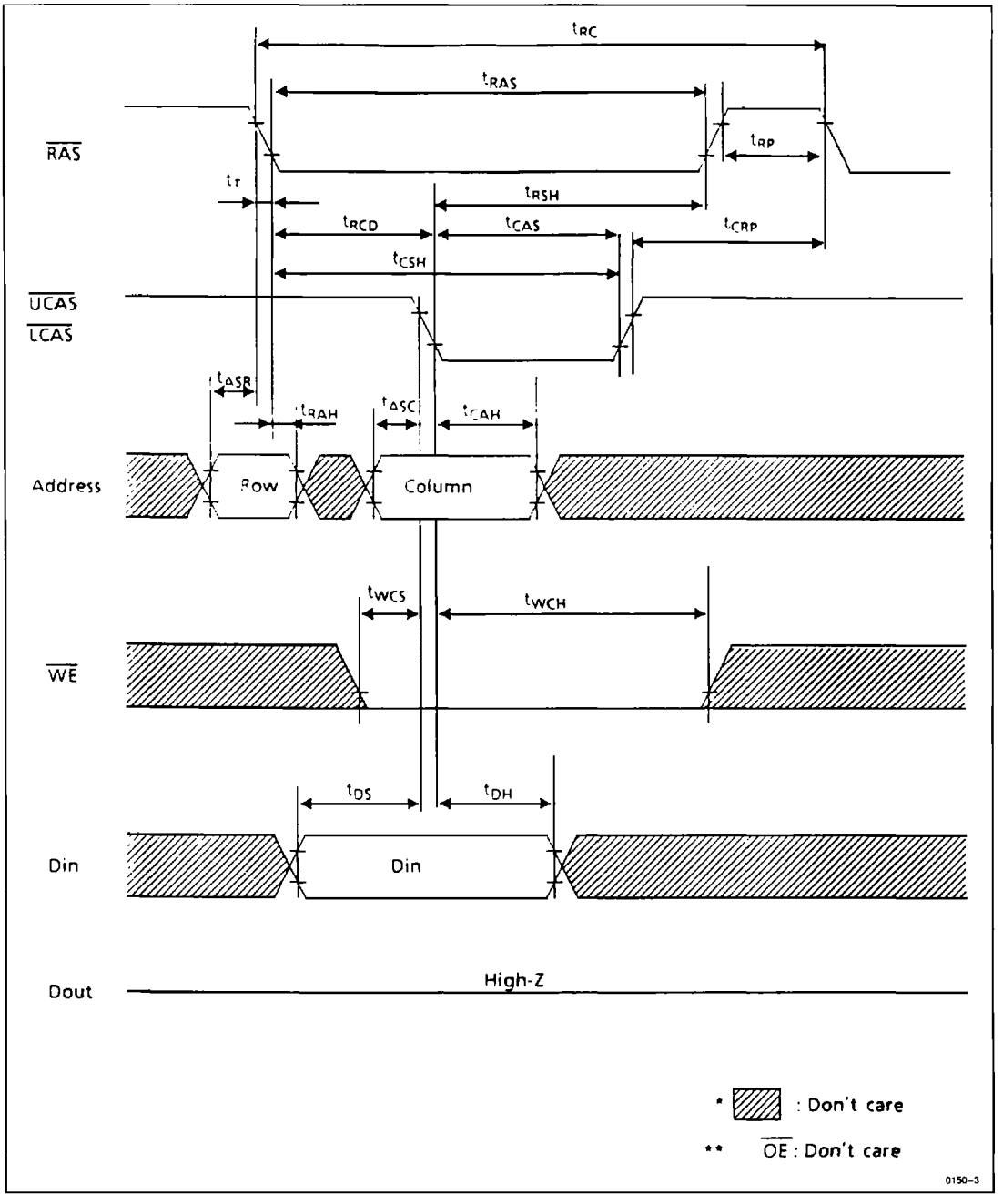
Notes:
1. AC measurements assume $t_T = 5$ ns.
2. Assumes that $t_{RCD} \leq t_{RCD}$ (max) and $t_{RAD} \leq t_{RAD}$ (max). If t_{RCD} or t_{RAD} is greater than the maximum recommended value shown in this table, t_{RAC} exceeds the value shown.
3. Measured with a load circuit equivalent to 2TTL loads and 100 pF.
4. Assumes that $t_{RCD} \geq t_{RCD}$ (max) and $t_{RAD} \leq t_{RAD}$ (max).
5. Assumes that $t_{RCD} \leq t_{RCD}$ (max) and $t_{RAD} \geq t_{RAD}$ (max).
6. t_{OFF} (max) defines the time at which the output achieves the open circuit condition and is not referenced to output voltage levels.
7. V_{IH} (min) and V_{IL} (max) are reference levels for measuring timing of input signals. Also, transition times are measured between V_{IH} and V_{IL}.
8. Operation with the t_{RCD} (max) limit insures that t_{RAC} (max) can be met, t_{RCD} (max) is specified as a reference point only, if t_{RCD} is greater than the specified t_{RCD} (max) limit, then access time is controlled exclusively by t_{CAC}.
9. Operation with the t_{RAD} (max) limit insures that t_{RAC} (max) can be met, t_{RAD} (max) is specified as a reference point only, if t_{RAD} is greater than the specified t_{RAD} (max) limit, then access time is controlled exclusively by t_{AA}.
10. t_{WCS}, t_{RWD}, t_{CWD} and t_{AWD} are not restrictive operating parameters. They are included in the data sheet as electrical characteristics only: if $t_{WCS} \geq t_{WCS}$ (min), the cycle is an early write cycle and the data out pin will remain open circuit (high impedance) throughout the entire cycle; if $t_{RWD} \geq t_{RWD}$ (min), $t_{CWD} \geq t_{CWD}$ (min), $t_{AWD} \geq t_{AWD}$ (min) and $t_{CPW} \geq t_{CPW}$ (min), the cycle is a read-modify-write and the data output will contain data read from the selected cell; if neither of the above sets of conditions is satisfied, the condition of the data out (at access time) is indeterminate.
11. These parameters are referenced to $\overline{CAS}$ leading edge in an early write cycle and to $\overline{WE}$ leading edge in a delayed write or a read-modify-write cycle.
12. t_{RASC} defines $\overline{RAS}$ pulse width in fast page mode cycles.
13. Access time is determined by the longer of t_{AA} or t_{CAC} or t_{ACP}.
14. An initial pause of 100 μs is required after power up followed by a minimum of eight initialization cycles ($\overline{RAS}$ only refresh cycle or $\overline{CAS}$ before $\overline{RAS}$ refresh cycle). If the internal refresh counter is used, a minimum of eight $\overline{CAS}$ before $\overline{RAS}$ refresh cycles is required.
15. In delayed write or read-modify-write cycles, $\overline{OE}$ must disable output buffer prior to applying data to the device.
16. Either t_{RCH} or T_{RRH} must be satisfied for a read cycle.
17. When both $\overline{LCAS}$ and $\overline{UCAS}$ go low at the same time, all 16 bits data are written into the device. $\overline{LCAS}$ or $\overline{UCAS}$ cannot be staggered within the same write/read cycles.

■ TIMING WAVEFORMS

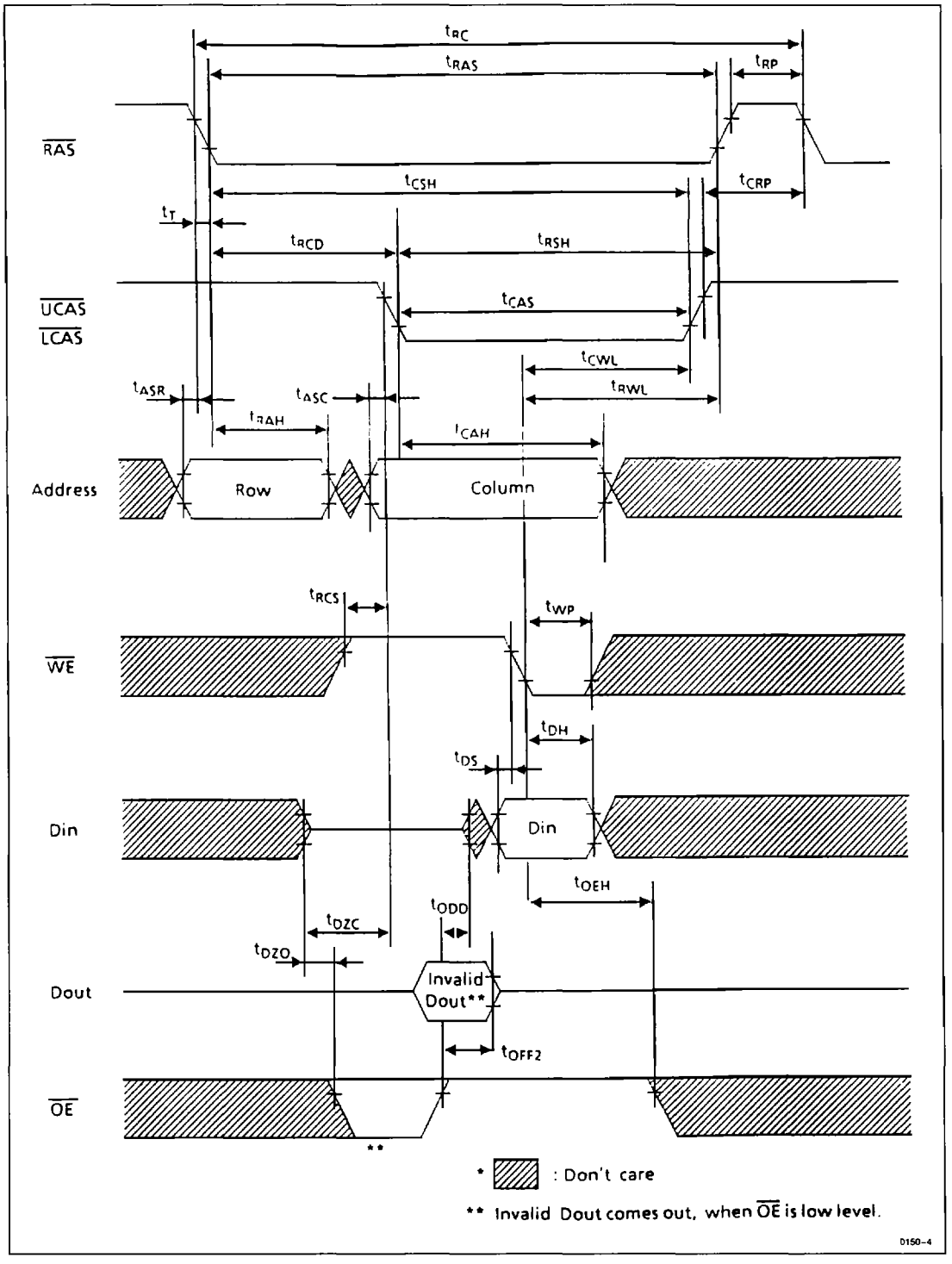
• Read Cycle



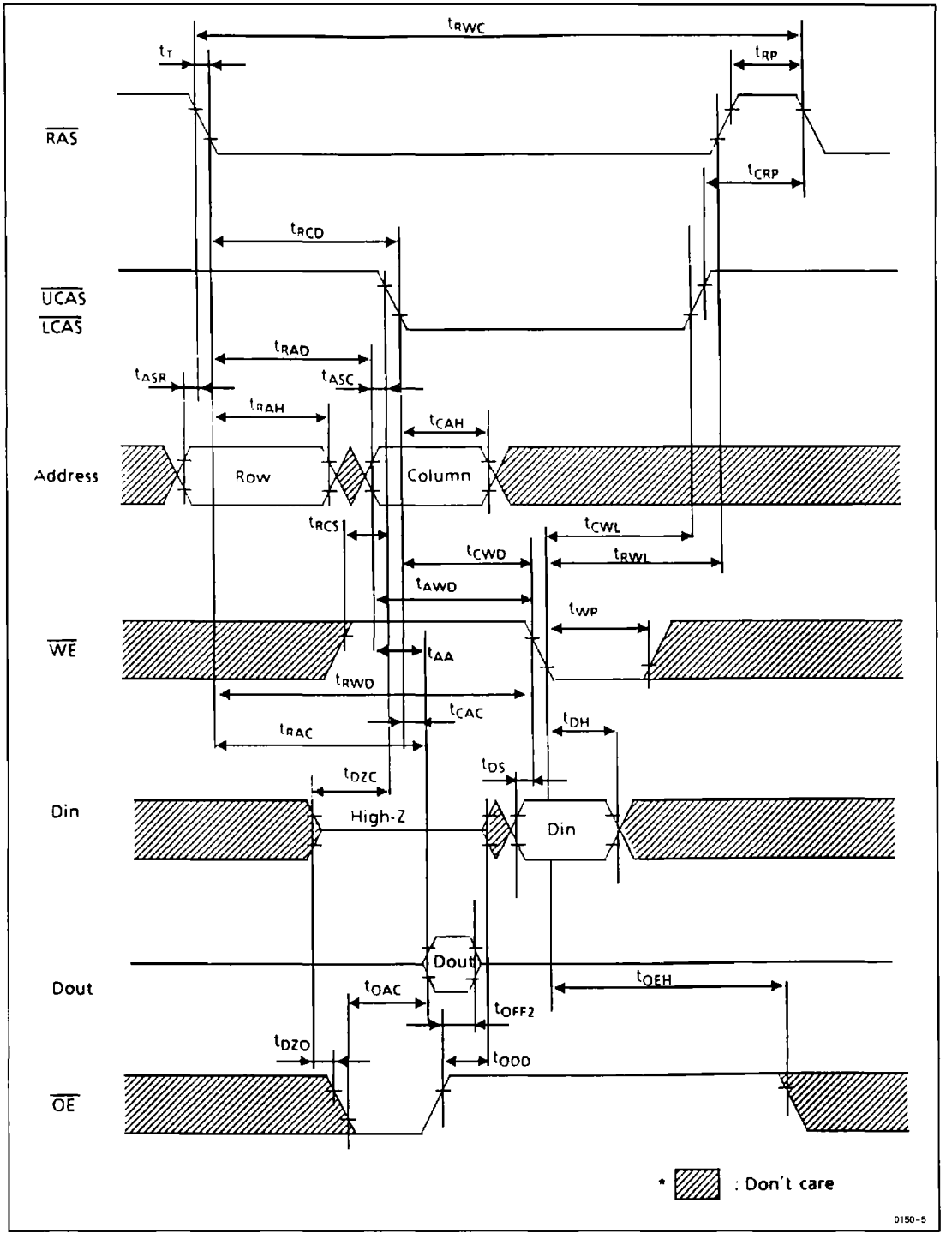
• **Early Write Cycle**



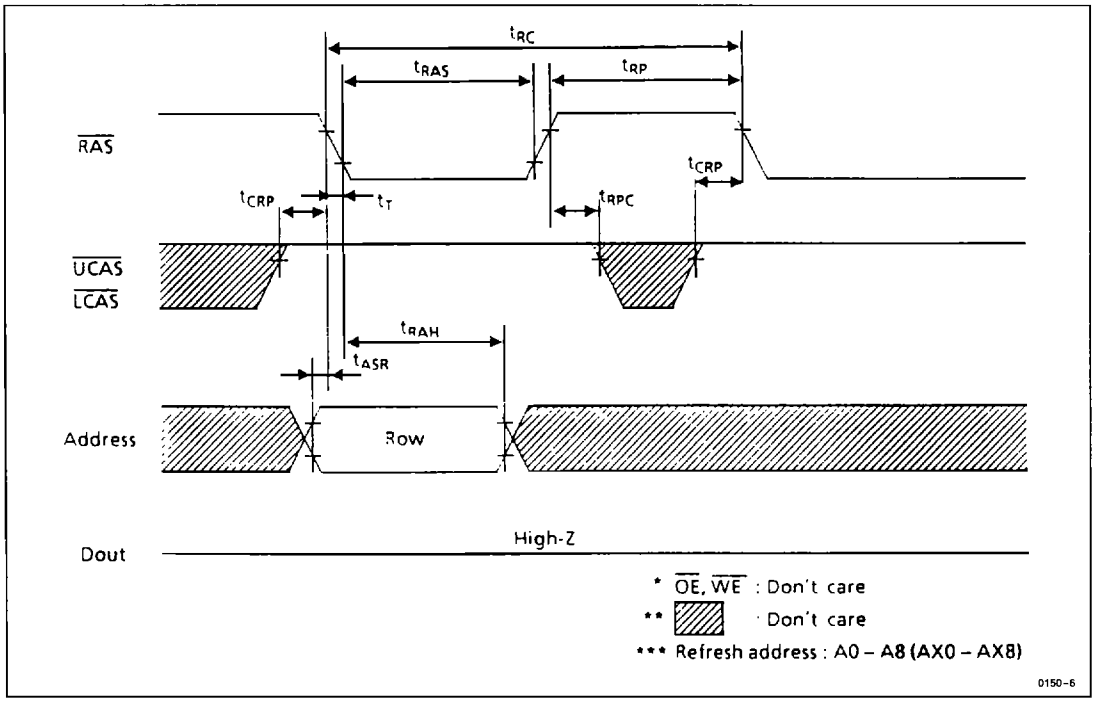
• **Delayed Write Cycle**



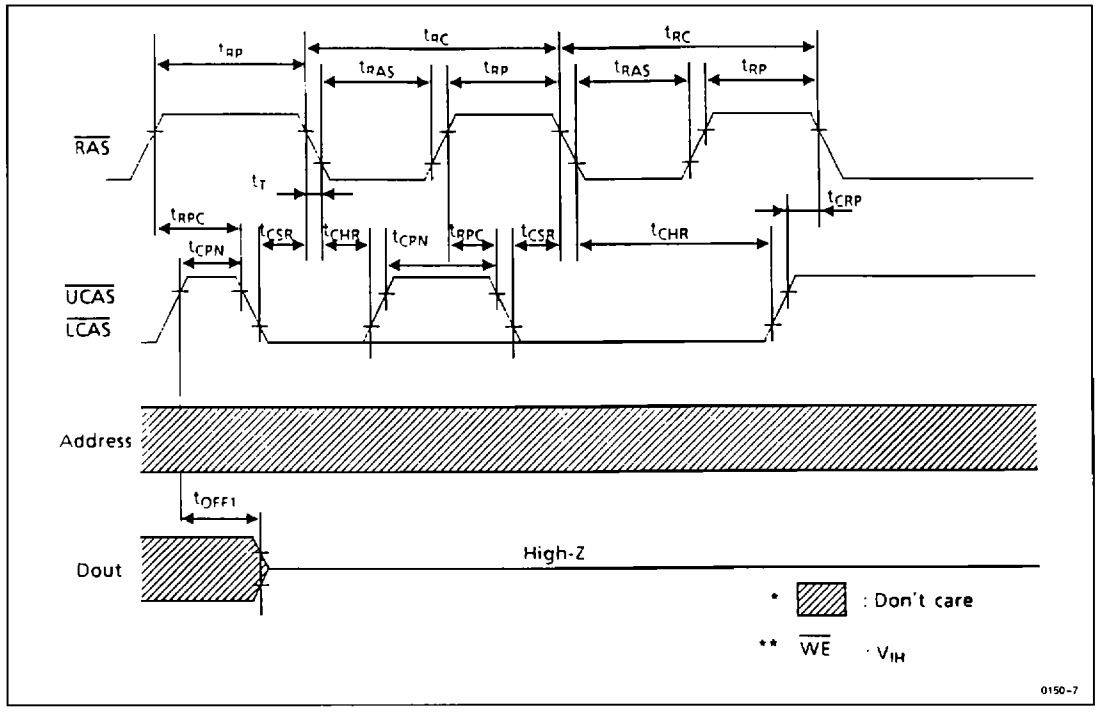
• **Read-Modify-Write Cycle**



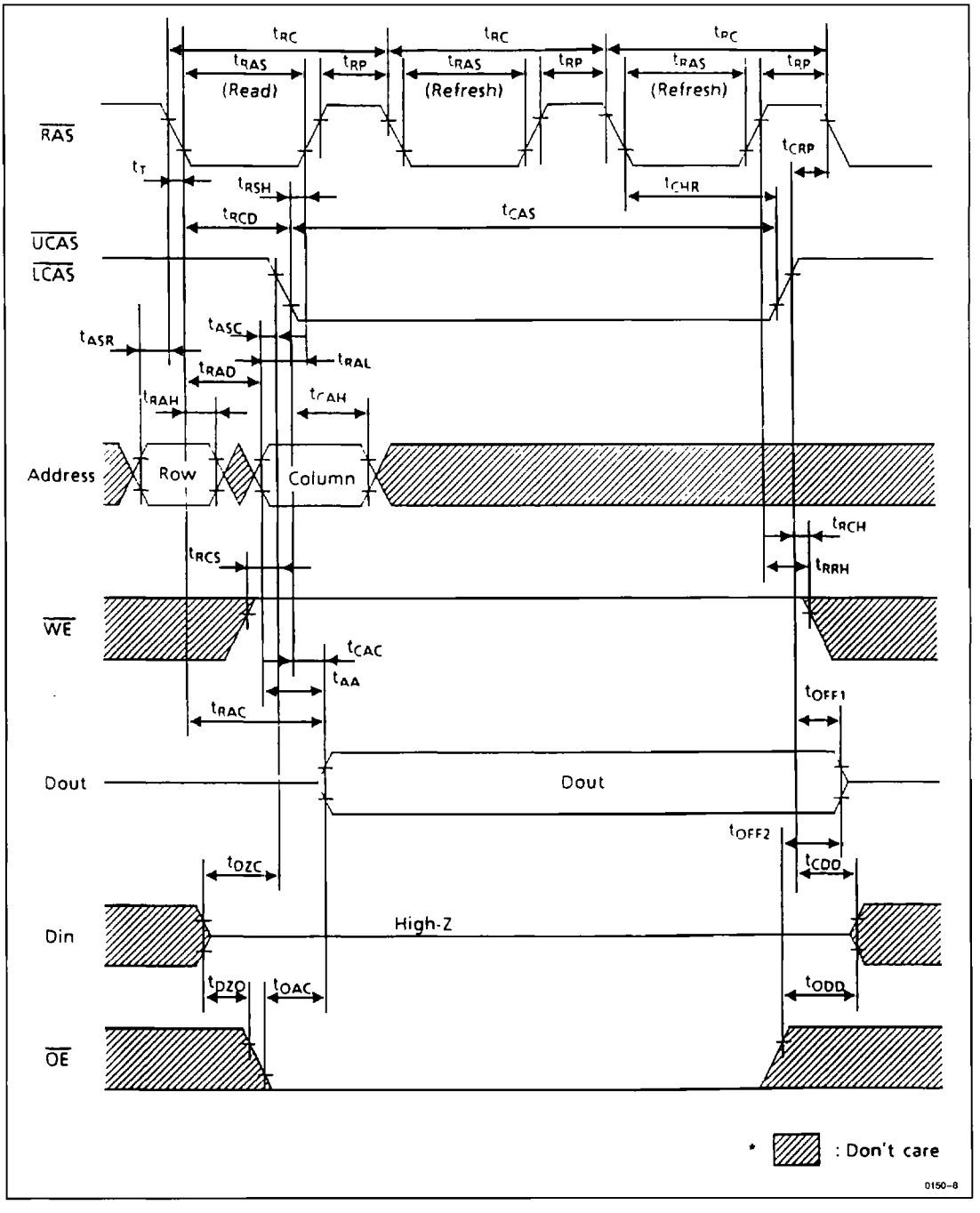
• **$\overline{RAS}$ Only Refresh Cycle**



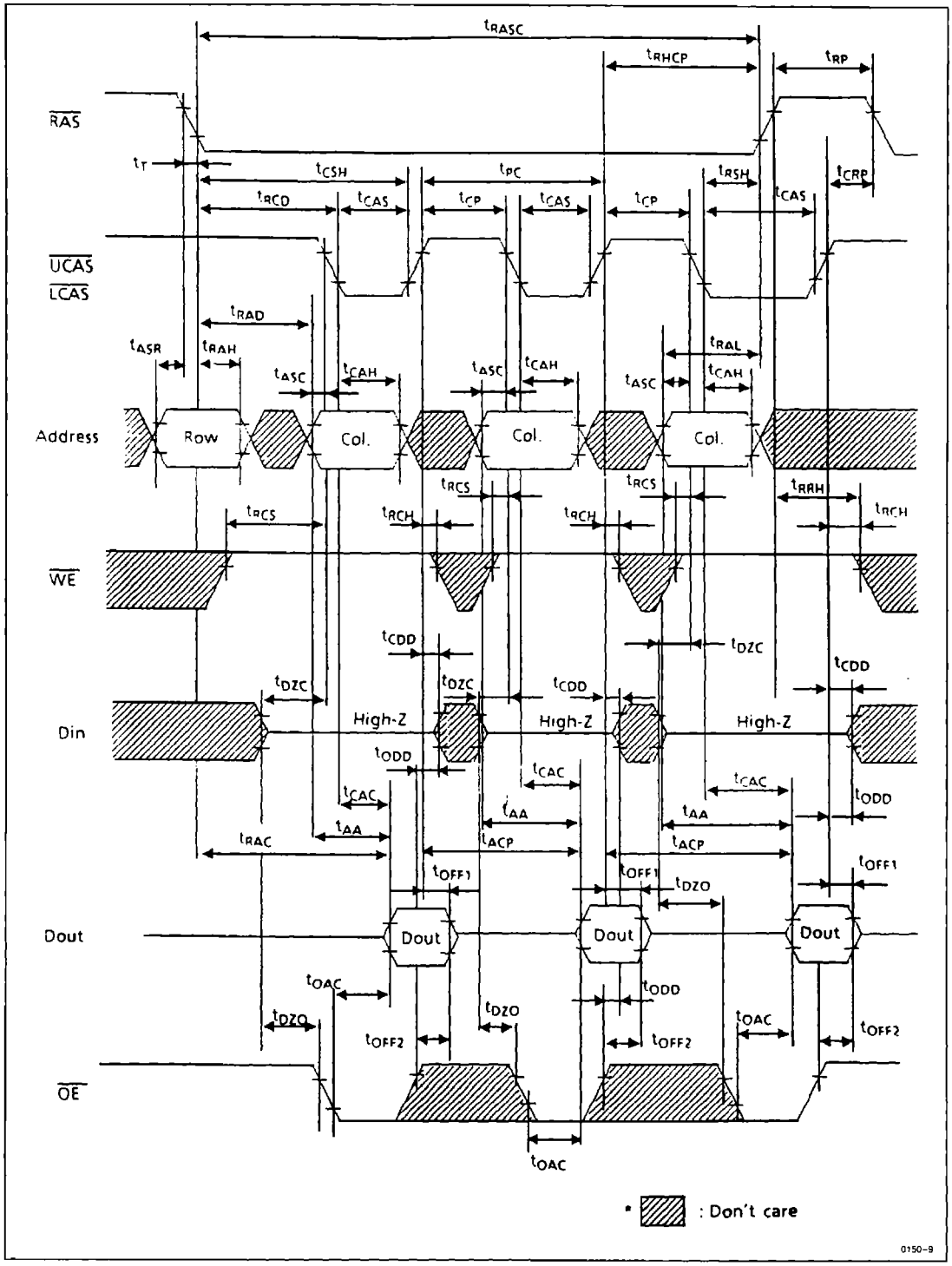
• **$\overline{CAS}$ Before $\overline{RAS}$ Refresh Cycle**



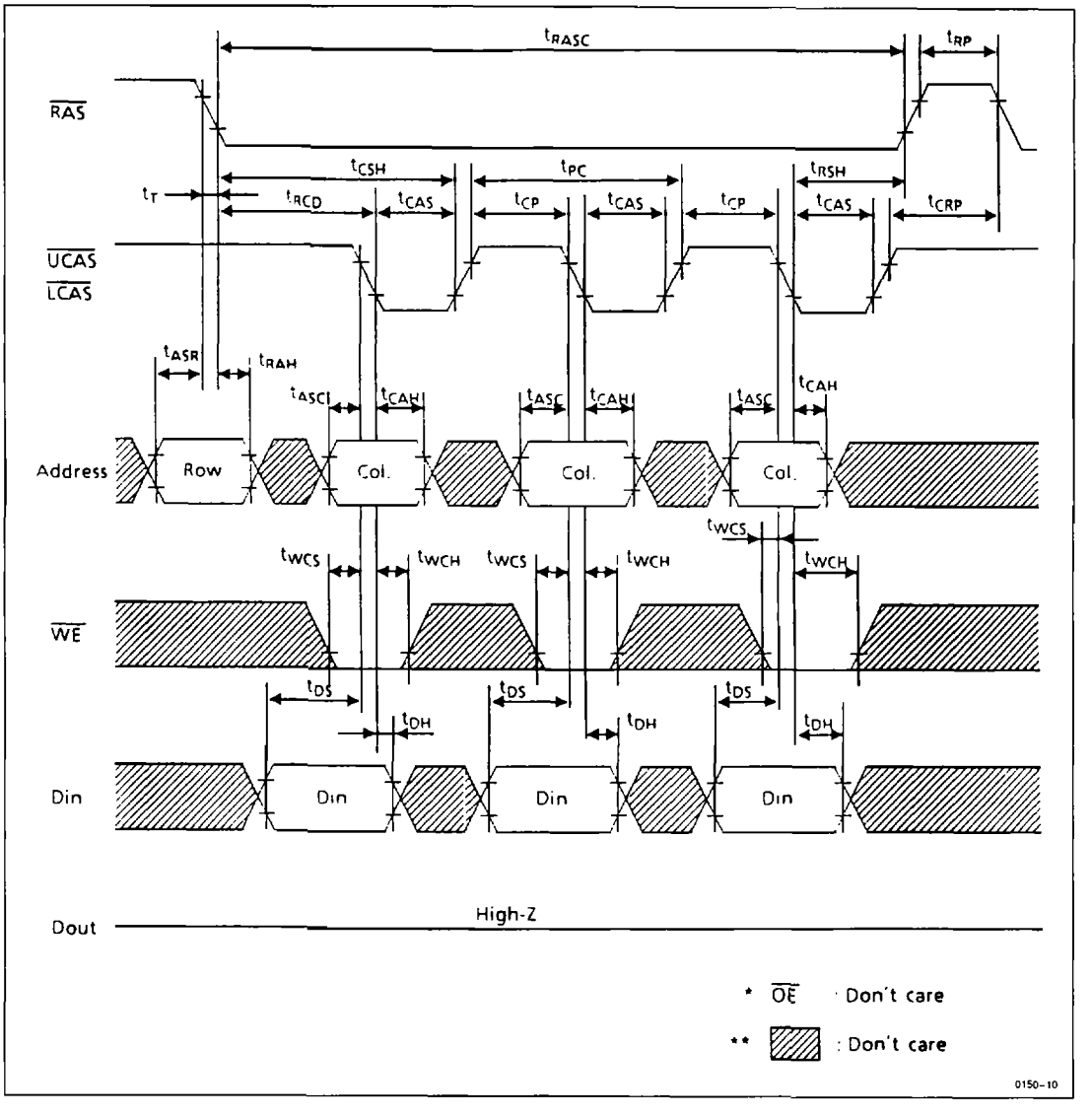
• Hidden Refresh Cycle



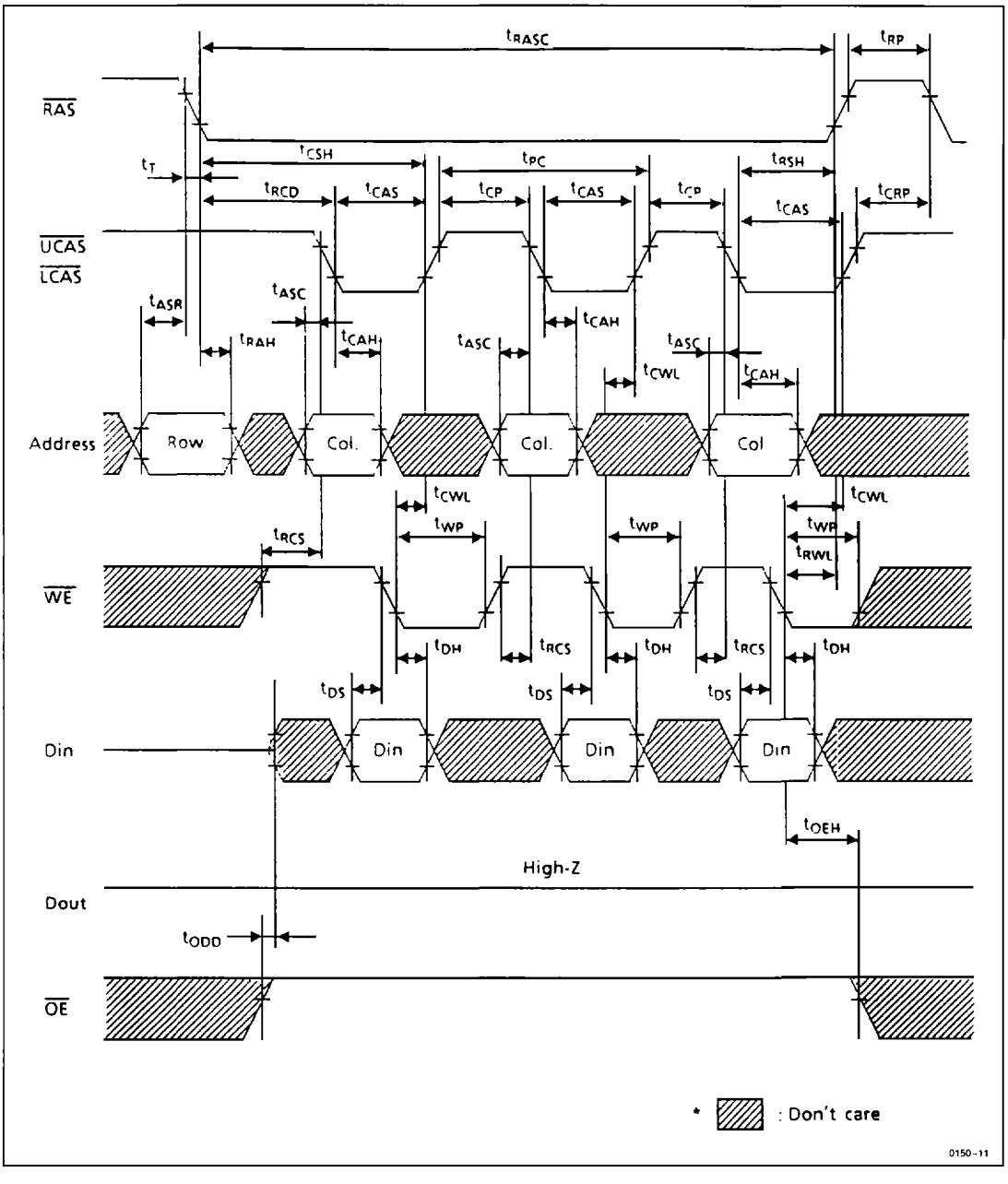
• **Fast Page Mode Read Cycle**



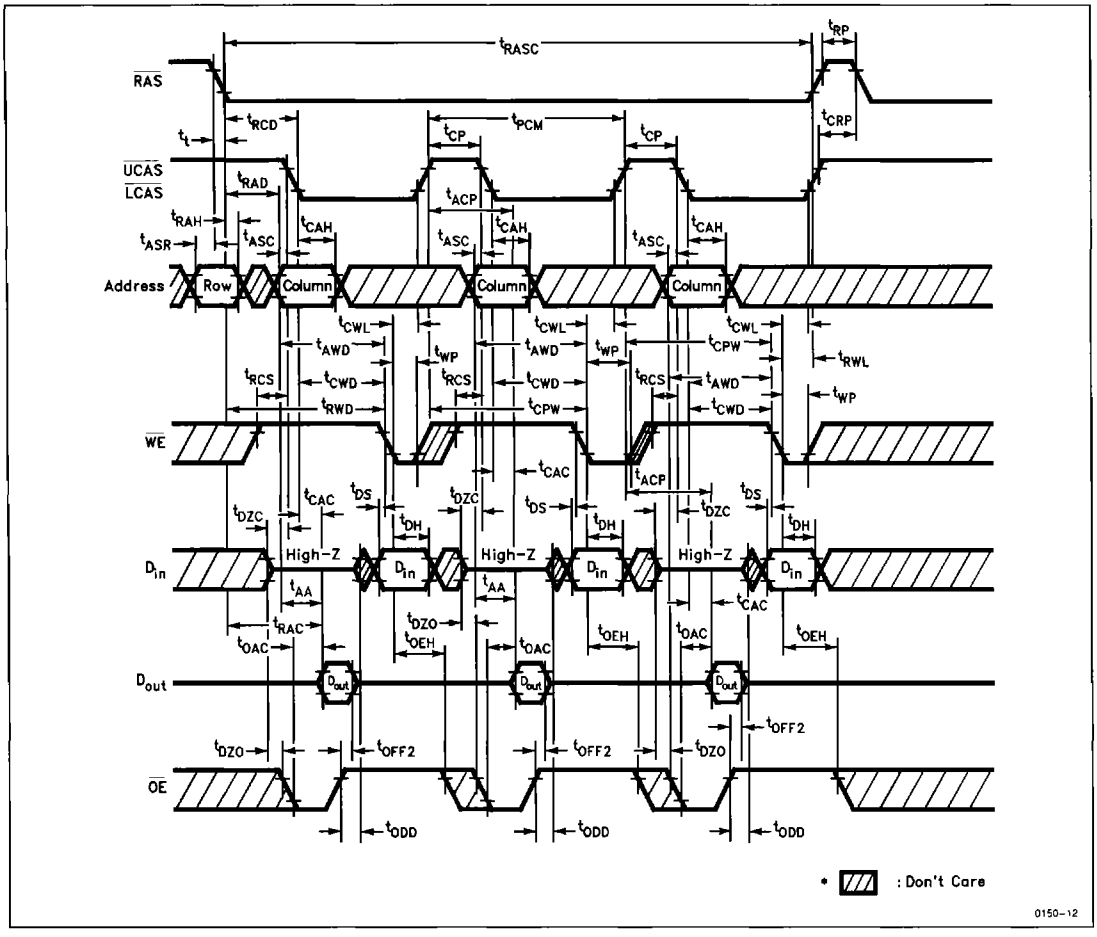
• **Fast Page Mode Early Write Cycle**



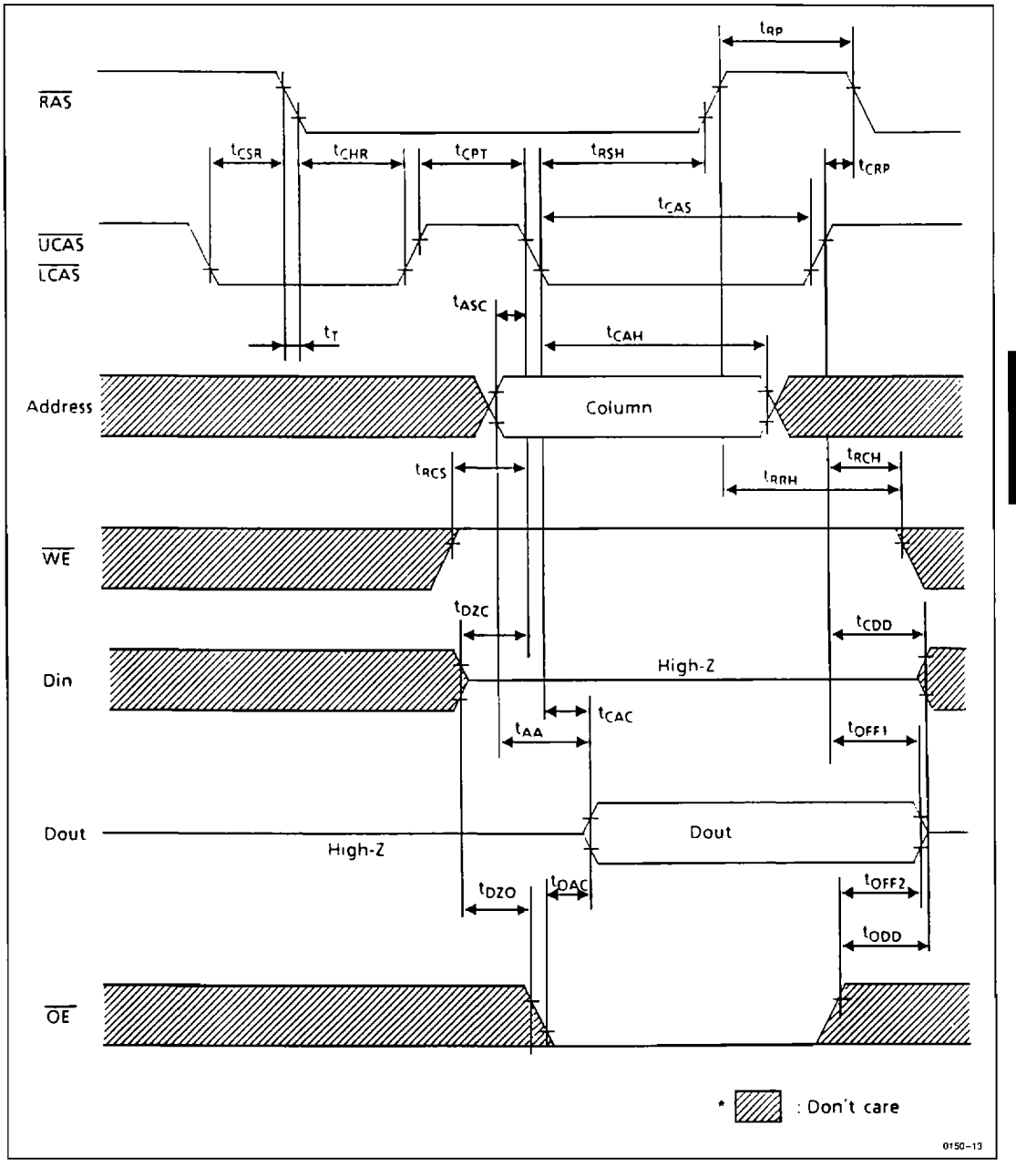
• **Fast Page Mode Delayed Write Cycle**



• **Fast Page Mode Read-Modify-Write Cycle**



• $\overline{CAS}$ Before $\overline{RAS}$ Refresh Counter Check Cycle (Read)



• $\overline{CAS}$ Before $\overline{RAS}$ Refresh Counter Check Cycle (Write)